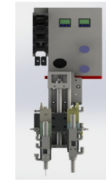


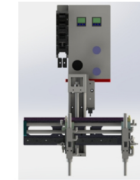
HP-730

选择性涂覆机

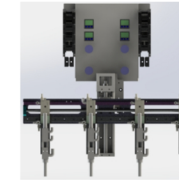
Selective Coating Machine



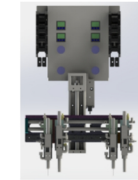
HP-730



HP-7302



HP-7304



HP-730C

设备参数 / Equipment parameters

型号	HP-730	HP-7302	HP-7304	HP-730C
外型尺寸 External dimensions	L1060mm*W1300mm*H1700mm			
设备平台 Device Platform	T5不锈钢板 T5 stainless steel plate			
控制方式 Control mode	工控机+板卡控制 Industrial computer+board control			
编程方式 Programming method	手动示教 Manual teaching			
PCB传输高度 PCB transmission height	910 ± 20mm			
运输速度 Transportation speed	0-5000mm/min			
输送方式 Conveying method	链条输送 Chain conveyer			
传输马达 Transmission motor	马达减速机 Motor acceleration reducer			
输送宽度 Conveying width	50-450mm可调 50-450mm adjustable			
元器高度 Element height	上下MAX: 110mm Up and down MAX: 110mm			
宽度调节方式 Width adjustment method	智能电动调节 Intelligent electric adjustment			
三轴驱动 Three axis drive	伺服电机+精密丝杆模组驱动 Servo motor+precision screw module drive			
运行速度 running speed	MAX: 800mm/s			
重复精度 Repetitive accuracy	± 0.2mm			
胶阀类型 Rubber valve type:	一点一喷 Little by little spray	双阀同步, 间距可调 Dual valve synchronization, adjustable spacing	四阀同步, 间距可调 Four valve synchronization, adjustable spacing	两点两喷, 组间距可调 Two points and two sprays, with adjustable group spacing
料桶容积 Bucket volume	10L 供胶桶+2L 清洗桶 10L glue supply bucket+2L cleaning bucket			
设备电源 Equipment power supply	AC220V 50Hz 1.8KW			
设备气源 Equipment air source	4-6kgf/cm ²			
设备重量 Equipment weight	Approx.500KG			
标配功能 Standard features	自带清洗功能, 自带照明光源和荧光检测光源 Equipped with cleaning function, Equipped with lighting source and fluorescence detection light source			

设备功能 / Device Functions

- ※ X、Y、Z三轴运动, 准确实现各种电路板避开连接器等非涂覆区域的选择性喷涂工艺。
- ※ 可以实现点涂、线状喷涂、曲线喷涂等多轨迹喷涂, 能完成高密度复杂电路板喷涂工艺。
- ※ 可以有效均匀涂覆器件边沿, 可以消除喷涂阴影效应。
- ※ 具有高速、高可靠性、高稳定性的传动和控制系统。
- ※ 能实现高密度复杂电路板喷涂及点胶工艺。
- ※ 编程方式: 软件程序具有数据输入自动编程;
- ※ 整线对接: 设备配有SMT行业标准SMEMA接口, 可以其他设备进行信号对接。

- ※ X, Y, Z three axis movement, accurately achieving selective spraying technology for various circuit boards to avoid non coated areas such as connectors.
- ※ It can achieve multi trajectory spraying such as point coating, linear spraying, and curve spraying, and can complete high-density and complex circuit board spraying processes.
- ※ It can effectively evenly coat the edges of the device and eliminate the shadow effect of spraying.
- ※ A transmission and control system with high speed, high reliability, and high stability.
- ※ Capable of achieving high-density complex circuit board spraying and dispensing processes.
- ※ Programming mode: the software program has data input Automatic programming;
- ※ Whole line docking: The equipment is equipped with SMT industry standard SMEMA interfaces, which can be used for signal docking with other devices.